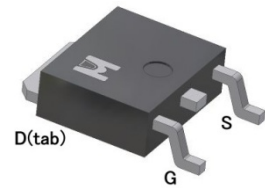
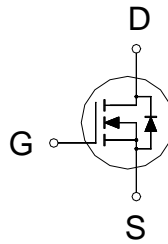


N-Channel Logic Level Enhancement Mode Field Effect Transistor

Product Summary:

|                            |     |
|----------------------------|-----|
| BV <sub>DSS</sub>          | 25V |
| R <sub>DS(on)</sub> (MAX.) | 6mΩ |
| I <sub>D</sub>             | 80A |



UIS, R<sub>g</sub> 100% Tested

Pb-Free Lead Plating & Halogen Free



ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25 °C Unless Otherwise Noted)

| PARAMETERS/TEST CONDITIONS                     |   | SYMBOL                            | LIMITS     | UNIT |
|--|---|-----------------------------------|------------|------|
| Gate-Source Voltage                            |   | V <sub>GS</sub>                   | ±20        | V    |
| Continuous Drain Current                       | T <sub>C</sub> = 25 °C                              | I <sub>D</sub>                    | 80         | A    |
|  | T <sub>C</sub> = 100 °C                             |                                   | 50         |      |
| Pulsed Drain Current <sup>1</sup>              |   | I <sub>DM</sub>                   | 170        |      |
| Avalanche Current                              |   | I <sub>AS</sub>                   | 53         |      |
| Avalanche Energy                               | L = 0.1mH, I <sub>D</sub> =53A, R <sub>G</sub> =25Ω | E <sub>AS</sub>                   | 140        | mJ   |
| Repetitive Avalanche Energy <sup>2</sup>       | L = 0.05mH  | E <sub>AR</sub>                   | 40         |      |
| Power Dissipation                              | T <sub>C</sub> = 25 °C                              | P <sub>D</sub>                    | 69         | W    |
|  | T <sub>C</sub> = 100 °C                             |                                   | 27         |      |
| Operating Junction & Storage Temperature Range |   | T <sub>J</sub> , T <sub>stg</sub> | -55 to 150 | °C   |

100% UIS testing in condition of V<sub>D</sub>=15V, L=0.1mH, V<sub>G</sub>=10V, I<sub>L</sub>=40A, Rated V<sub>DS</sub>=25V N-CH

THERMAL RESISTANCE RATINGS

| THERMAL RESISTANCE  | SYMBOL           | TYPICAL | MAXIMUM | UNIT   |
|---------------------|------------------|---------|---------|--------|
| Junction-to-Case    | R <sub>θJC</sub> |         | 1.8     | °C / W |
| Junction-to-Ambient | R <sub>θJA</sub> |         | 75      |        |

<sup>1</sup>Pulse width limited by maximum junction temperature.

<sup>2</sup>Duty cycle ≤ 1%



ELECTRICAL CHARACTERISTICS (T<sub>c</sub> = 25 °C, Unless Otherwise Noted)

| PARAMETER   | SYMBOL                                | TEST CONDITIONS   | LIMITS  |      |      | UNIT |
|---|---------------------------------------|---|---|------|------|------|
|   |                                       |   | MIN   | TYP  | MAX  |      |
| <b>STATIC</b>   |                                       |   |   |      |      |      |
| Drain-Source Breakdown Voltage  | V <sub>(BR)DSS</sub>                  | V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA                          | 25  |      |      | V    |
| Gate Threshold Voltage  | V <sub>GS(th)</sub>                   | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA            | 1   | 1.5  | 3    |      |
| Gate-Body Leakage   | I <sub>GSS</sub>                      | V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±20V                          |   |      | ±100 | nA   |
| Zero Gate Voltage Drain Current   | I <sub>DSS</sub>                      | V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V                           |   |      | 1    | μA   |
|   |                                       | V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V, T <sub>J</sub> = 125 °C  |   |      | 25   |      |
| On-State Drain Current <sup>1</sup>   | I <sub>D(ON)</sub>                    | V <sub>DS</sub> = 10V, V <sub>GS</sub> = 10V                          | 80  |      |      | A    |
| Drain-Source On-State Resistance <sup>1</sup>                                 | R <sub>DS(ON)</sub>                   | V <sub>GS</sub> = 10V, I <sub>D</sub> = 30A                           |   | 5.3  | 6    | mΩ   |
|   |                                       | V <sub>GS</sub> = 5V, I <sub>D</sub> = 24A                            |   | 7.6  | 9.5  |      |
| Forward Transconductance <sup>1</sup>   | g <sub>fs</sub>                       | V <sub>DS</sub> = 5V, I <sub>D</sub> = 24A                            |   | 25   |      | S    |
| <b>DYNAMIC</b>  |                                       |   |   |      |      |      |
| Input Capacitance   | C <sub>iss</sub>                      | V <sub>GS</sub> = 0V, V <sub>DS</sub> = 15V, f = 1MHz                 |   | 1800 |      | pF   |
| Output Capacitance  | C <sub>oss</sub>                      |   |   | 480  |      |      |
| Reverse Transfer Capacitance  | C <sub>rss</sub>                      |   |   | 220  |      |      |
| Gate Resistance   | R <sub>g</sub>                        | V <sub>GS</sub> = 15mV, V <sub>DS</sub> = 0V, f = 1MHz                |   | 1.2  |      | Ω    |
| Total Gate Charge <sup>1,2</sup>  | Q <sub>g</sub> (V <sub>GS</sub> =10V) | V <sub>DS</sub> = 15V, V <sub>GS</sub> = 10V,<br>I <sub>D</sub> = 30A |   | 34.5 |      | nC   |
|   | Q <sub>g</sub> (V <sub>GS</sub> =5V)  |   |   | 22   |      |      |
| Gate-Source Charge <sup>1,2</sup>   | Q <sub>gs</sub>                       |   |   | 4.8  |      |      |
| Gate-Drain Charge <sup>1,2</sup>  | Q <sub>gd</sub>                       |   |   | 12.5 |      |      |
| Turn-On Delay Time <sup>1,2</sup>   | t <sub>d(on)</sub>                    |   | V <sub>DS</sub> = 15V,<br>I <sub>D</sub> = 25A, V <sub>GS</sub> = 10V, R <sub>GS</sub> = 2.7Ω |      | 20   |      |
| Rise Time <sup>1,2</sup>  | t <sub>r</sub>                        |   |   | 15   |      |      |
| Turn-Off Delay Time <sup>1,2</sup>  | t <sub>d(off)</sub>                   |   |   | 50   |      |      |
| Fall Time <sup>1,2</sup>  | t <sub>f</sub>                        |   |   | 20   |      |      |
| <b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T<sub>c</sub> = 25 °C)</b> |                                       |   |   |      |      |      |
| Continuous Current  | I <sub>S</sub>                        |   |   |      | 80   | A    |
| Pulsed Current <sup>3</sup>   | I <sub>SM</sub>                       |   |   |      | 170  |      |
| Forward Voltage <sup>1</sup>  | V <sub>SD</sub>                       | I <sub>F</sub> = I <sub>S</sub> , V <sub>GS</sub> = 0V                |   |      | 1.3  | V    |
| Reverse Recovery Time   | t <sub>rr</sub>                       | I <sub>F</sub> = I <sub>S</sub> , dI <sub>F</sub> /dt = 100A / μS     |   | 32   |      | nS   |
| Peak Reverse Recovery Current   | I <sub>RM(REC)</sub>                  |   |   | 200  |      | A    |
| Reverse Recovery Charge   | Q <sub>rr</sub>                       |   |   | 12   |      | nC   |

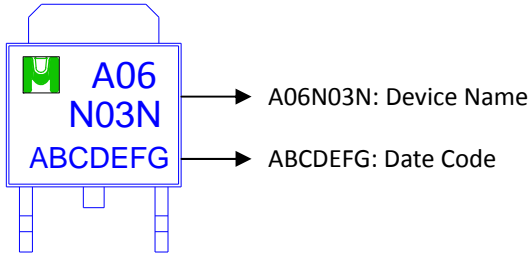
<sup>1</sup>Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

<sup>2</sup>Independent of operating temperature.

<sup>3</sup>Pulse width limited by maximum junction temperature.

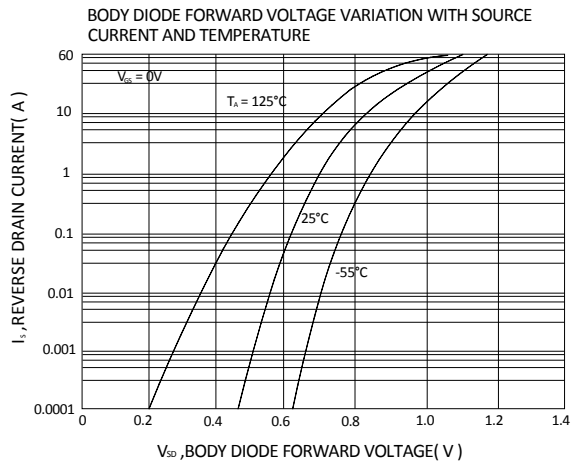
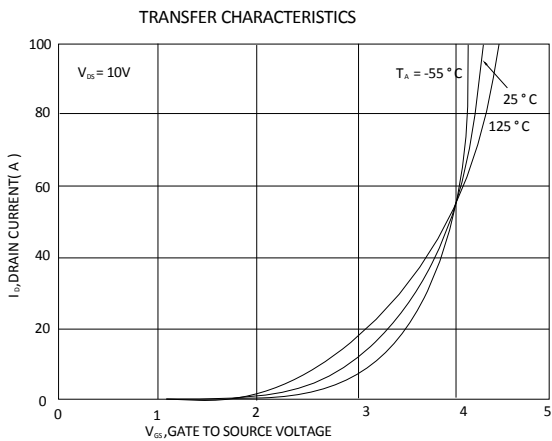
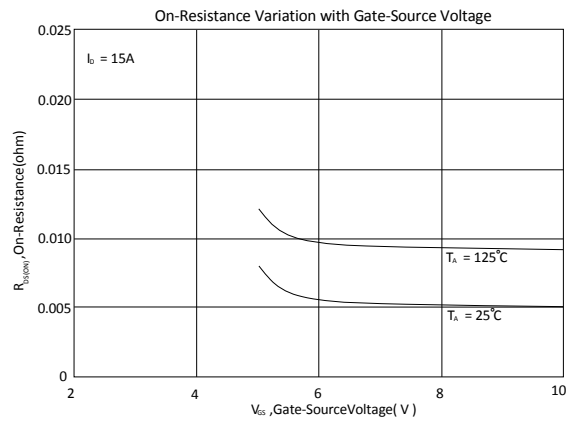
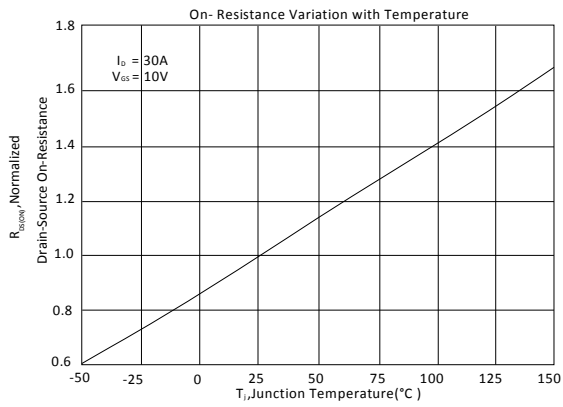
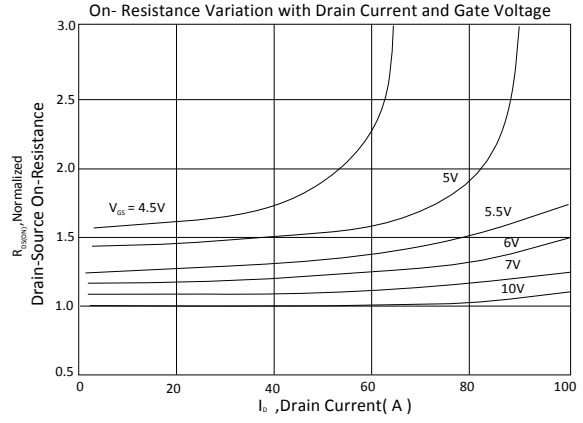
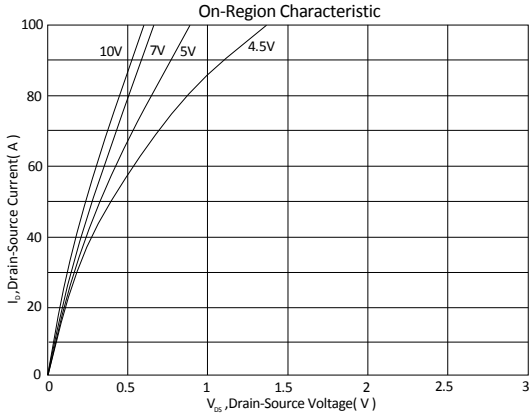
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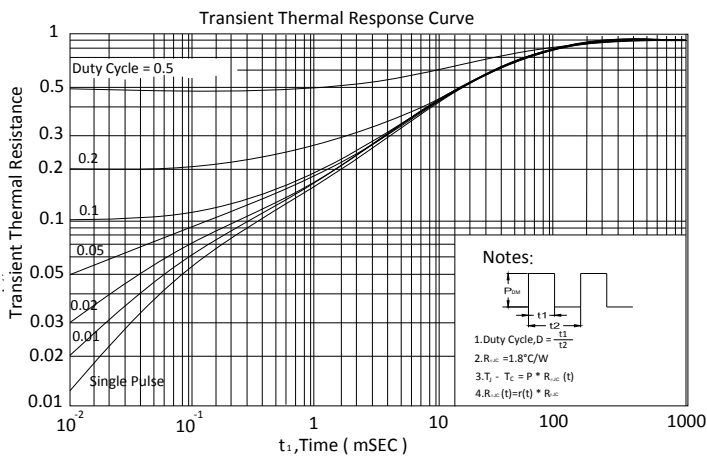
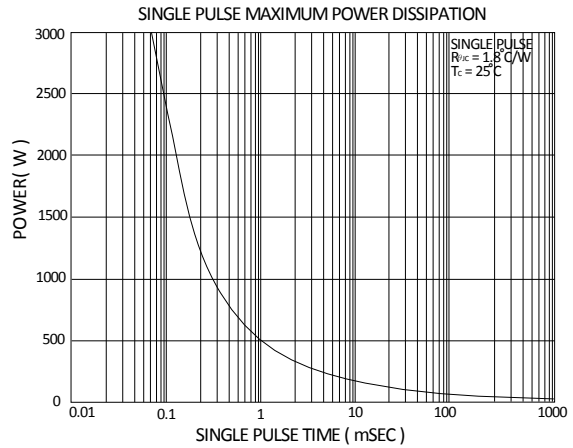
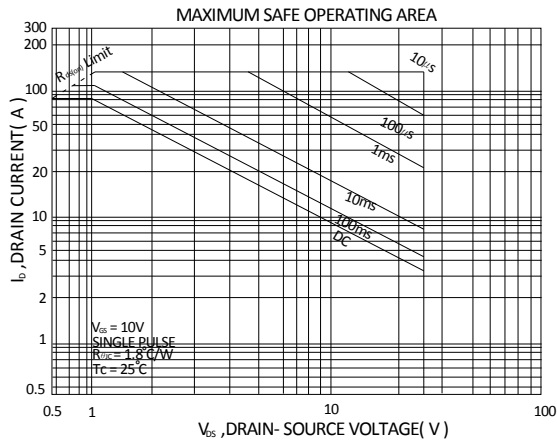
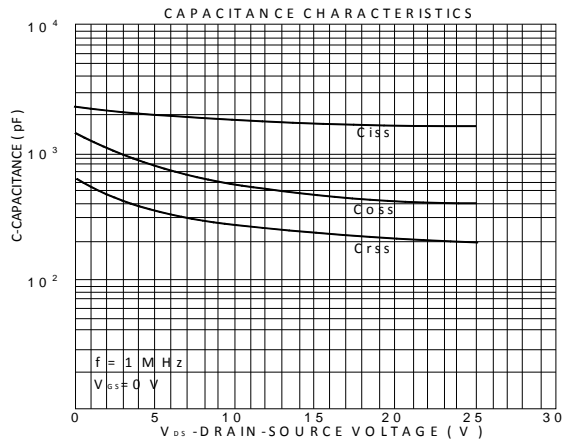
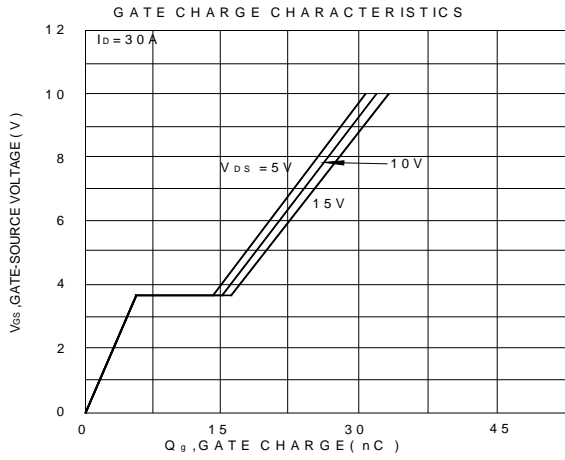
Device Name: EMA06N03AN for DPAK (TO-252)





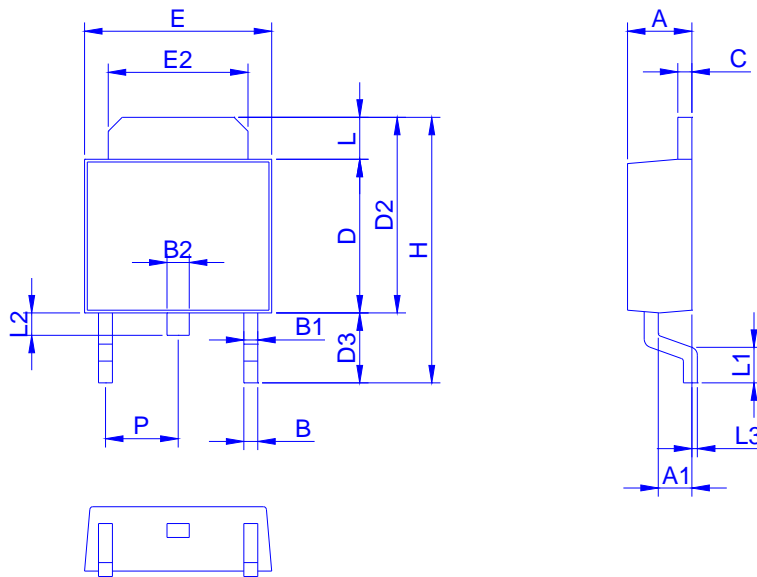
TYPICAL CHARACTERISTICS







Outline Drawing



| Dimension | A    | A1   | B    | B1   | B2   | C    | D    | D2   | D3   | E    | E2   | H     | L    | L1   | L2   | L3   | P    |
|-----------|------|------|------|------|------|------|------|------|------|------|------|-------|------|------|------|------|------|
| Min.      | 2.10 | 0.95 | 0.30 | 0.40 | 0.60 | 0.40 | 5.30 | 6.70 | 2.20 | 6.40 | 4.80 | 9.20  | 0.89 | 0.90 | 0.50 | 0.00 | 2.10 |
| Max.      | 2.50 | 1.30 | 0.85 | 0.94 | 1.00 | 0.60 | 6.20 | 7.30 | 3.00 | 6.70 | 5.45 | 10.15 | 1.70 | 1.65 | 1.10 | 0.30 | 2.50 |

Footprint

